

Top View

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Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

PowerPAK® 1212-8SH

| PRODUCT SUMMARY | | | | | | |
|---|--------|--|--|--|--|--|
| V _{DS} (V) | -30 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -10 \text{ V}$ | 0.0123 | | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$ | 0.0222 | | | | | |
| Q _g typ. (nC) | 20.5 | | | | | |
| I _D (A) ^{d, g} | -35 | | | | | |
| Configuration | Single | | | | | |

Bottom View

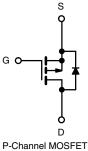
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Notebook battery charging
- Notebook adapter switch



| ORDERING INFORMATION | |
|---------------------------------|------------------|
| Package | PowerPAK 1212-8 |
| Lead (Pb)-free and halogen-free | SiSH617DN-T1-GE3 |

| PARAMETER | SYMBOL | LIMIT | UNIT | | |
|--|------------------------|-----------------------------------|-----------------------|------|--|
| Drain-source voltage | V_{DS} | -30 | V | | |
| Gate-source voltage | | V_{GS} | | ± 25 | |
| | T _C = 25 °C | | -35 ^d | | |
| Continuous drain surrent /T 150 °C) | T _C = 70 °C | | -35 ^d | | |
| Continuous drain current (T _J = 150 °C) | T _A = 25 °C | l _D | -13.9 ^{a, b} | | |
| | T _A = 70 °C | | -11.1 ^{a, b} | | |
| Pulsed drain current | | I _{DM} | -60 | Α | |
| Continuous source-drain diode current | T _C = 25 °C | | -35 ^d | | |
| | T _A = 25 °C | l _s | -3 ^{a, b} | | |
| valanche current | | I _{AS} | -29 | | |
| Single-pulse avalanche energy | L = 0.1 mH | E _{AS} | 42 | mJ | |
| | T _C = 25 °C | | 52 | | |
| Maximum power dissipation | T _C = 70 °C | | 33 | w | |
| | T _A = 25 °C | P _D | 3.7 ^{a, b} | - vv | |
| | T _A = 70 °C | | 2.4 ^{a, b} | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C | |
| Soldering recommendations (peak temperature) | Ŭ | 260 | 1 | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT |
| Maximum junction-to-ambient a, c | t ≤ 10 s | R _{thJA} | 26 | 33 | °C/W |
| Maximum junction-to-case | Steady state | R_{thJC} | 1.9 | 2.4 | C/VV |

Notes

- a. Surface mounted on 1" x 1" FR4 board
- t = 10 s
- c. Maximum under steady state conditions is 81 °C/W
- d. Package limited
- See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Based on T_C = 25 °C



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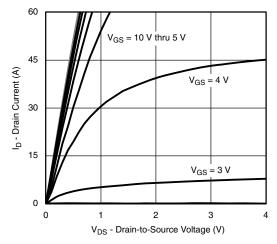
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-------------------------|--|------|--------|--------|-------|
| Static | | | | • | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | -30 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | J 050 A | - | -25 | - | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = -250 μA | - | 4.7 | - | mv/-C |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | -1.2 | - | -2.5 | V |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | - | - | ± 100 | nA |
| Zara gata valtaga drain aurrant | | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | -1 | μΑ |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ | - | - | -5 | |
| On-state drain current a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$ | -30 | - | - | Α |
| Drain-source on-state resistance a | В | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | 0 | | | |
| Dialii-Source oii-state resistance " | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, I_D = -10.3 \text{ A}$ | - | 0.0185 | 0.0222 | 1 22 |
| Forward transconductance ^a | 9 _{fs} | V _{DS} = -15 V, I _D = -13.9 A | - | 35 | - | S |
| Dynamic ^b | | | | | | |
| Input capacitance | C _{iss} | | - | 1800 | - | |
| Output capacitance | C _{oss} | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 370 | - | pF |
| Reverse transfer capacitance | C _{rss} | | - | 312 | - | |
| Total gate charge | 0 | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -13.9 \text{ A}$ | - | 39 | 59 | |
| Total gate charge | Q_g | | - | 20.5 | 31 | 20 |
| Gate-source charge | Q_{gs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -13.9 \text{ A}$ | - | 6 | - | IIC |
| Gate-drain charge | Q_{gd} | | - | 11 | - | |
| Gate resistance | R_g | f = 1 MHz | 0.4 | 2 | 4 | Ω |
| Turn-on delay time | t _{d(on)} | | - | 11 | 22 | |
| Rise time | t _r | | - | 9 | 18 | |
| Turn-off delay time | t _{d(off)} | $I_D \cong$ -11.1 A, V_{GEN} = -10 V, R_g = 1 Ω | - | 32 | 50 | |
| Fall time | t _f | | - | 9 | 18 |] " |
| Turn-on delay time | t _{d(on)} | | - | 40 | 60 | 115 |
| Rise time | t _r | | - | 43 | 65 | |
| Turn-off delay time | t _{d(off)} | $I_D \cong -11.1 \text{ A, } V_{GEN} = -4.5 \text{ V, } R_g = 1 \Omega$ | - | 30 | 45 | |
| Fall time | t _f | | - | 11 | 22 | |
| Drain-Source Body Diode Character | stics | | | | | |
| Continuous source-drain diode current | I _S | T _C = 25 °C | - | - | -35 | А |
| Pulse diode forward current | I _{SM} | | - | - | -60 | |
| Body diode voltage | V_{SD} | I _S = -11.1 A, V _{GS} = 0 V | - | -0.8 | -1.2 | V |
| Body diode reverse recovery time | t _{rr} | | - | 33 | 50 | ns |
| Body diode reverse recovery charge | Q _{rr} | l _F = -11.1 A, di/dt = 100 A/μs, | - | 30 | 45 | nC |
| Reverse recovery fall time | t _a | T _J = 25 °C | - | 18 | - | |
| Reverse recovery rise time | t _b | 1 | _ | 16 | - | ns |

Notes

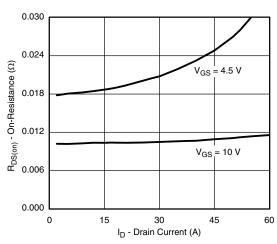
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

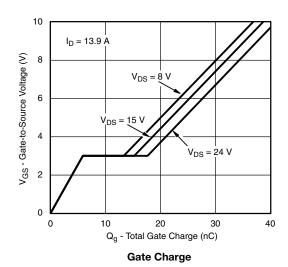


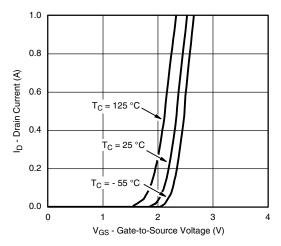


Output Characteristics

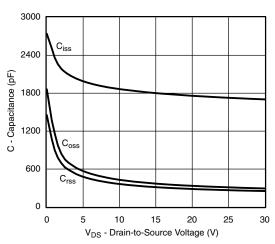


On-Resistance vs. Drain Current

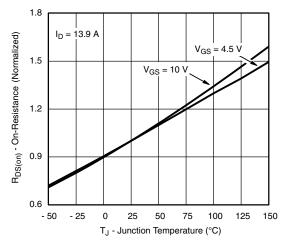




Transfer Characteristics

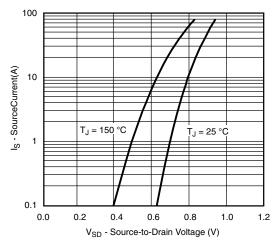


Capacitance

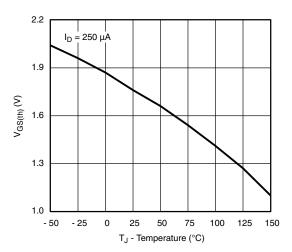


On-Resistance vs. Junction Temperature

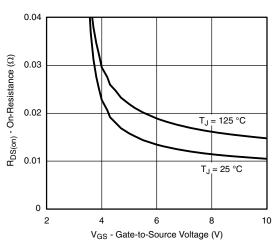




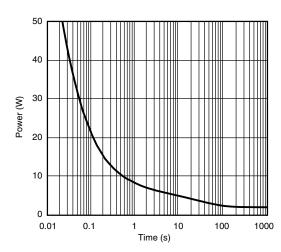
Source-Drain Diode Forward Voltage



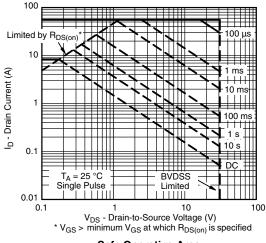
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

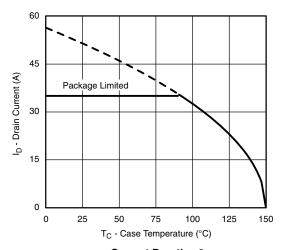


Single Pulse Power, Junction-to-Ambient

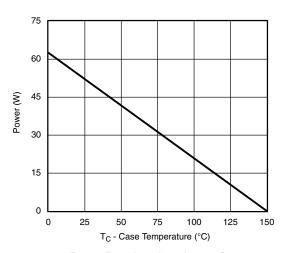


Safe Operating Area

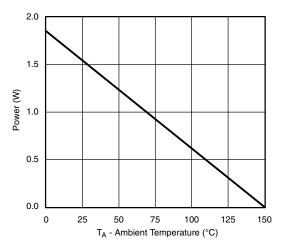




Current Derating a





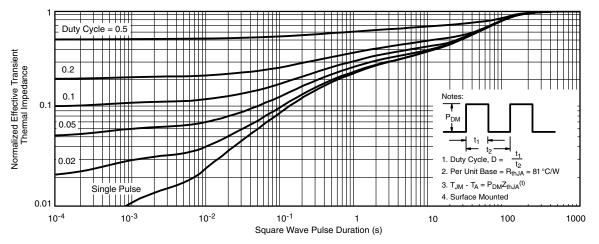


Power Derating, Junction-to-Ambient

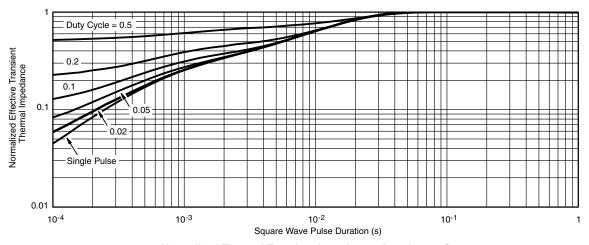
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



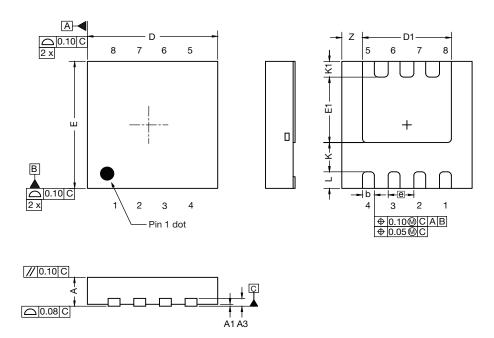
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75900.



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Case Outline for PowerPAK® 1212-SWLH and PowerPAK® 1212-8SH



| DIM | MILLIMETERS | | | INCHES | | | |
|------|-------------|------|------|------------|-------|-------|--|
| DIM. | MIN. | NOM. | MAX. | MIN. NOM. | NOM. | MAX. | |
| Α | 0.82 | 0.90 | 0.98 | 0.032 | 0.035 | 0.038 | |
| A1 | 0.00 | - | 0.05 | 0.000 | - | 0.002 | |
| A3 | 0.20 ref. | | | 0.008 ref. | | | |
| b | 0.25 | 0.30 | 0.35 | 0.010 | 0.012 | 0.014 | |
| D | 3.20 | 3.30 | 3.40 | 0.126 | 0.130 | 0.134 | |
| D1 | 2.15 | 2.25 | 2.35 | 0.085 | 0.089 | 0.093 | |
| E | 3.20 | 3.30 | 3.40 | 0.126 | 0.130 | 0.134 | |
| E1 | 1.60 | 1.70 | 1.80 | 0.063 | 0.067 | 0.071 | |
| е | 0.65 bsc. | | | 0.026 bsc. | | | |
| K | 0.76 ref. | | | 0.030 ref. | | | |
| K1 | 0.41 ref. | | | 0.016 ref. | | | |
| L | 0.33 | 0.43 | 0.53 | 0.013 | 0.017 | 0.021 | |
| Z | 0.525 ref. | | | 0.021 ref. | | | |

DWG: 6062



RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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